PTO/SB/02B

Docket No.: 5000-1-443

## **DECLARATION AND POWER OF ATTORNEY**

As a below named inventor (s), I hereby declare that:

My residence, post office address and citizenship are as stated below pext to my name.

I helieve I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

## OPTICAL ELEMENT MODULE PACKAGE AND METHOD FOR MANUFACTURING THE SAME

was filed on	as United States Ap	plication Number or PCT International Application
Number	and was amended o	n(if applicable).
I hereby state that I have revi	iewed and understand the cont	ents of the above identified specification, including the
claims, as amended by any a	mendment referred to above.	
acknowledge the duty to dis	sclose information which is ma	iterial to patentability as defined in Title 37, Code of
rederai Kegulanon, 9 1.36.		•
bereat of macingly celement	e histor delow and have also id	ed States Code, § 119 of any foreign application(s) fentified below any foreign application for patent or application on which priority is claimed.
Prior Foreign Application(s)		
2003-35965	Danublia a 6 W	Priority Claimed
(Number)	Republic of Korea (Country)	(Day/Month/Year Filed)
(Number)	(Country)	(Day/Month/Year Filed)
hereby claim the benefit und nd, insofar as the subject ma pplication in the manner pro- he duty to disclose information 1.56 which occurred between	ier Title 35, United States Cod ter of each of the claims of the vided by the first paragraph of on which is material to patents	(Day/Month/Year Filed)  e, 120 of any United States application(s) listed being application is not disclosed in the prior United States the Trite 35. United States Code, §112, I acknowled bility as defined in Title 37, Code of Federal Regular plication and the national or PCT international filing
hereby claim the benefit und nd, insofar as the subject ma pplication in the manner pro- he duty to disclose information	ier Title 35, United States Cod ter of each of the claims of the vided by the first paragraph of on which is material to patents	(Day/Month/Year Filed) le, 120 of any United States application(s) listed below application is not disclosed in the prior United State the Trite 35. United States Code, §112, I acknowled bility as defined in Title 37, Code of Federal Regular plication and the national or PCT international filing

## **CUSTOMER NUMBER**

for the law firm of CHA & REITER, said attorneys or agents with full power of substitution and revocation to prosecute this application and transact all business in the Patent and Trademark Office connected therewith.

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I (we) hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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